

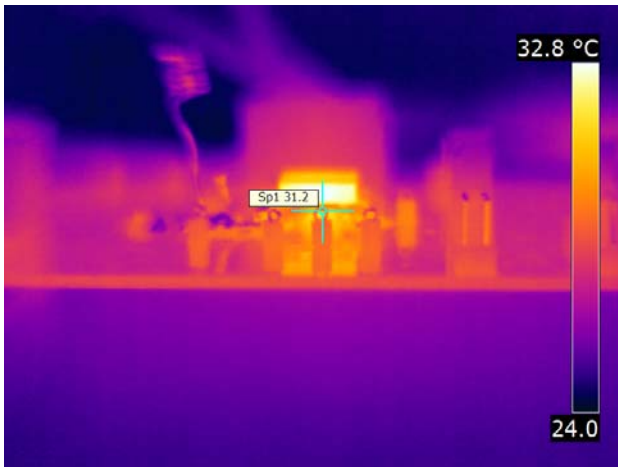
**Report Date** 12/3/2014

**Company** Texas Instruments  
**Address** 1000 CentreGreen Way,  
 Suite 100, Cary, NC  
 27513

**Customer**  
**Site Address**

**Thermographer** A.S.

**Contact Person**



**Image and Object Parameters**

**Camera Model** FLIR T300

**Text Comments**

**Due to location of the IC, the measurement data is just an estimate and may not be accurate**

**Image Date** 12/3/2014 4:00:51 PM

**Image Name** IR\_0326.jpg

**Emissivity** 0.98

**Reflected apparent temperature** 25.0 °C

**Object Distance** 0.8 ft

**Description**

Vin=12V, Vout=3.3V, Iout=0A

**Report Date** 12/3/2014

**Company** Texas Instruments  
**Address** 1000 CentreGreen Way,  
 Suite 100, Cary, NC  
 27513

**Customer**  
**Site Address**

**Thermographer** A.S.

**Contact Person**



### Image and Object Parameters

**Camera Model** FLIR T300

### Text Comments

**Due to location of the IC, the measurement data is just an estimate and may not be accurate**

**Image Date** 12/3/2014 4:13:32 PM

**Image Name** IR\_0327.jpg

**Emissivity** 0.98

**Reflected apparent temperature** 25.0 °C

**Object Distance** 0.8 ft

### Description

Vin=12V, Vout=3.3V, Iout=10A

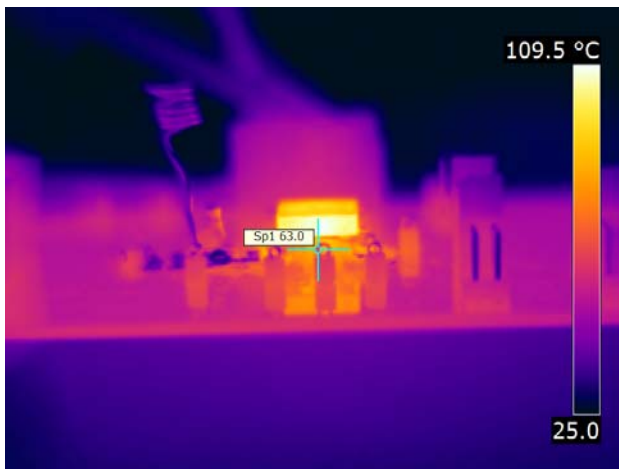
**Report Date** 12/3/2014

**Company** Texas Instruments  
**Address** 1000 CentreGreen Way,  
 Suite 100, Cary, NC  
 27513

**Customer**  
**Site Address**

**Thermographer** A.S.

**Contact Person**



### Image and Object Parameters

**Camera Model** FLIR T300

### Text Comments

**Due to location of the IC, the measurement data is just an estimate and may not be accurate**

**Image Date** 12/3/2014 4:24:44 PM

**Image Name** IR\_0328.jpg

**Emissivity** 0.98

**Reflected apparent temperature** 25.0 °C

**Object Distance** 0.8 ft

### Description

Vin=12V, Vout=3.3V, Iout=20A

**Report Date** 12/3/2014

**Company** Texas Instruments  
**Address** 1000 CentreGreen Way,  
 Suite 100, Cary, NC  
 27513

**Customer**  
**Site Address**

**Thermographer** A.S.

**Contact Person**



**Image and Object Parameters**

**Camera Model** FLIR T300

**Text Comments**

**Due to location of the IC, the measurement data is just an estimate and may not be accurate**

**Image Date** 12/3/2014 4:42:33 PM

**Image Name** IR\_0329.jpg

**Emissivity** 0.98

**Reflected apparent temperature** 25.0 °C

**Object Distance** 0.8 ft

**Description**

Vin=12V, Vout=5V, Iout=0A

**Report Date** 12/3/2014

**Company** Texas Instruments  
**Address** 1000 CentreGreen Way,  
 Suite 100, Cary, NC  
 27513

**Customer**  
**Site Address**

**Thermographer** A.S.

**Contact Person**



### Image and Object Parameters

**Camera Model** FLIR T300

### Text Comments

**Due to location of the IC, the measurement data is just an estimate and may not be accurate**

**Image Date** 12/3/2014 4:54:21 PM

**Image Name** IR\_0330.jpg

**Emissivity** 0.98

**Reflected apparent temperature** 25.0 °C

**Object Distance** 0.8 ft

### Description

Vin=12V, Vout=5V, Iout=10A

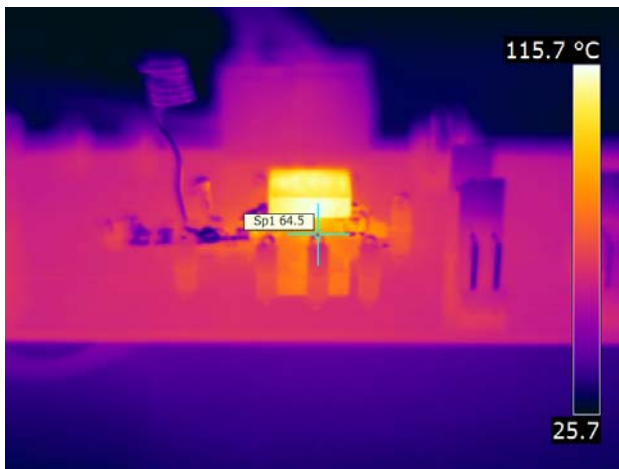
**Report Date** 12/3/2014

**Company** Texas Instruments  
**Address** 1000 CentreGreen Way,  
 Suite 100, Cary, NC  
 27513

**Customer**  
**Site Address**

**Thermographer** A.S.

**Contact Person**



### Image and Object Parameters

**Camera Model** FLIR T300

### Text Comments

**Due to location of the IC, the measurement data is just an estimate and may not be accurate**

**Image Date** 12/3/2014 5:06:06 PM

**Image Name** IR\_0331.jpg

**Emissivity** 0.98

**Reflected apparent temperature** 25.0 °C

**Object Distance** 0.8 ft

### Description

Vin=12V, Vout=5V, Iout=20A

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